

RF Transformer

50Ω 1650 to 2850 MHz

NCS1-292-4+



CASE STYLE: GE0805C-1

Maximum Ratings

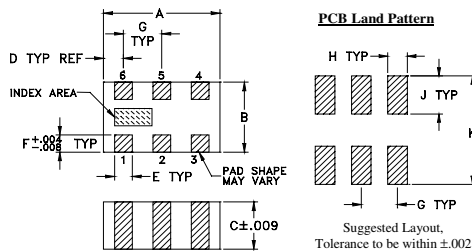
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Input RF Power***	3W
*** Derate linearly to 2W at 85°C	
Permanent damage may occur if any of these limits are exceeded.	

Pad Connections

PRIMARY DOT (Unbalanced Port)	1
PRIMARY (GND)	2
SECONDARY DOT (Balanced)	4
SECONDARY (Balanced)	3
NO CONNECTION	6
NOT USED (GND Externally)	5

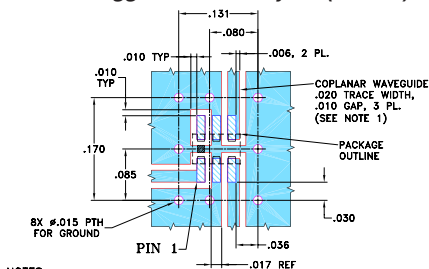
Pads 2,3,4 are DC-connected internally

Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F
.079	.049	.033	.014	.012	.012
2.01	1.24	0.84	0.36	0.30	0.30
G	H	J	K	wt	
.026	.014	.039	.110	grams	
0.66	0.36	1.00	2.80	.008	

Demo Board MCL P/N: TB-419+
Suggested PCB Layout (PL-264)

Features

- wideband, 1650 to 2850 MHz
- low phase unbalance, 4 deg. and amplitude unbalance, 0.4 dB typ.
- miniature size, 0.079"x0.049"x0.033"
- LTCC construction
- low cost
- aqueous washable

Applications

- WLAN
- WIMAX/WIBRO
- MMDS
- radar
- WCDMA

Electrical Specifications (T_{AMB} = 25°C)

RATIO	FREQUENCY (MHz)	INSERTION* LOSS (dB)	PHASE UNBALANCE AT SECONDARY† (Deg.) Typ.	AMPLITUDE UNBALANCE (dB) Typ.
1	1650-2850	1.0	4	0.4

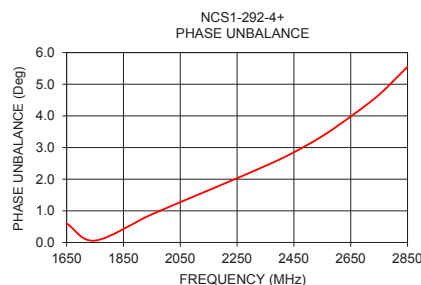
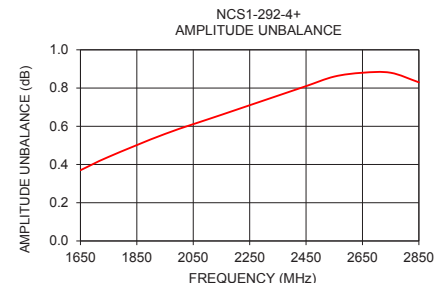
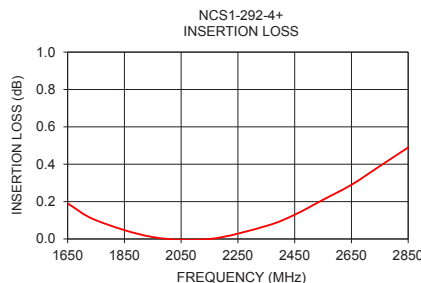
* Insertion Loss is referenced to mid-band loss, 0.7 dB. Reference Demo Board TB-419+

† Relative to 180°

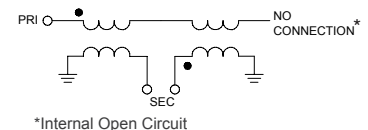
Typical Performance Data at 25°C**

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
1650.00	0.19	12.97	0.37	0.60
1750.00	0.10	14.96	0.44	0.06
1950.00	0.01	20.60	0.56	0.89
2150.00	0.00	25.71	0.66	1.65
2350.00	0.07	19.38	0.76	2.42
2450.00	0.13	16.90	0.81	2.85
2550.00	0.21	15.01	0.86	3.36
2650.00	0.29	13.59	0.88	3.98
2750.00	0.39	12.46	0.88	4.67
2850.00	0.49	11.59	0.83	5.55

** Measured with Agilent E5071B network analyzer using impedance conversion and port extension.



configuration J

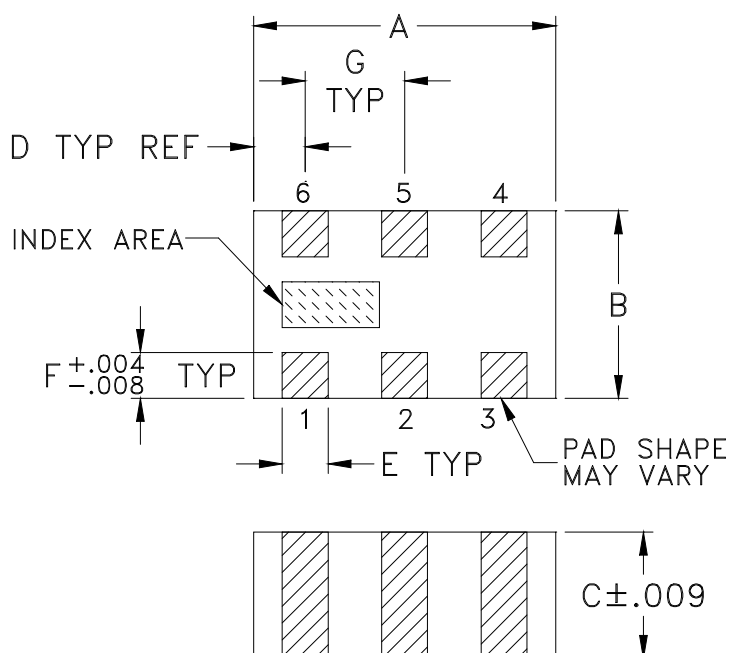


Notes

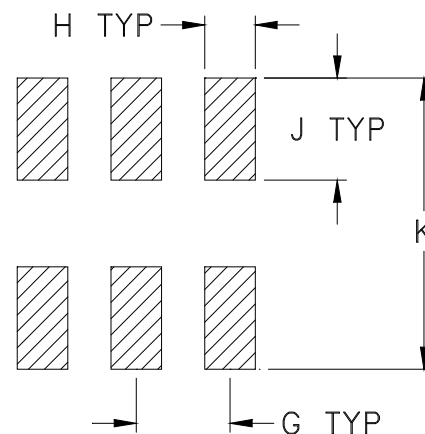
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Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
GE0805C-1	.079 (2.00)	.049 (1.25)	.033 (0.84)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Style: Tin-lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F74

DEVICE ORIENTATION IN T&R

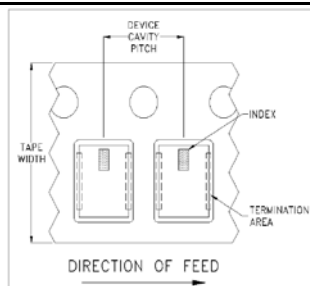


ILLUSTRATION 1

Applicable Case Styles

GE0805C-1
GE0805C-1AP
JV1210C-1
GU2939

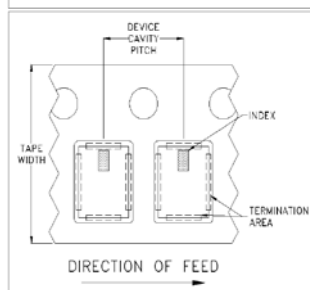


ILLUSTRATION 2

Applicable Case Styles

JV1210C
JV1210C-2
JV1210C-3
JV1210C-4
JV1210C-5
JV1210C-6
JV1210C-11

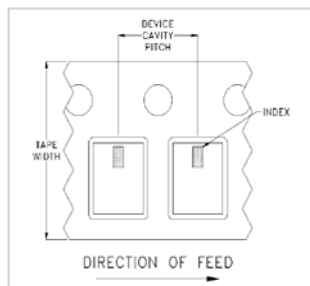


ILLUSTRATION 3

Applicable Case Styles

JC0603C-8
JV1210C-7
JV1210C-8
JV1210C-9
JV1210C-10
JV1210C-13
GE0805C-13

Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	2000
				4000

Note: Small reel availability varies by model. Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

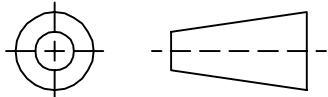


INTERNET <http://www.minicircuits.com>

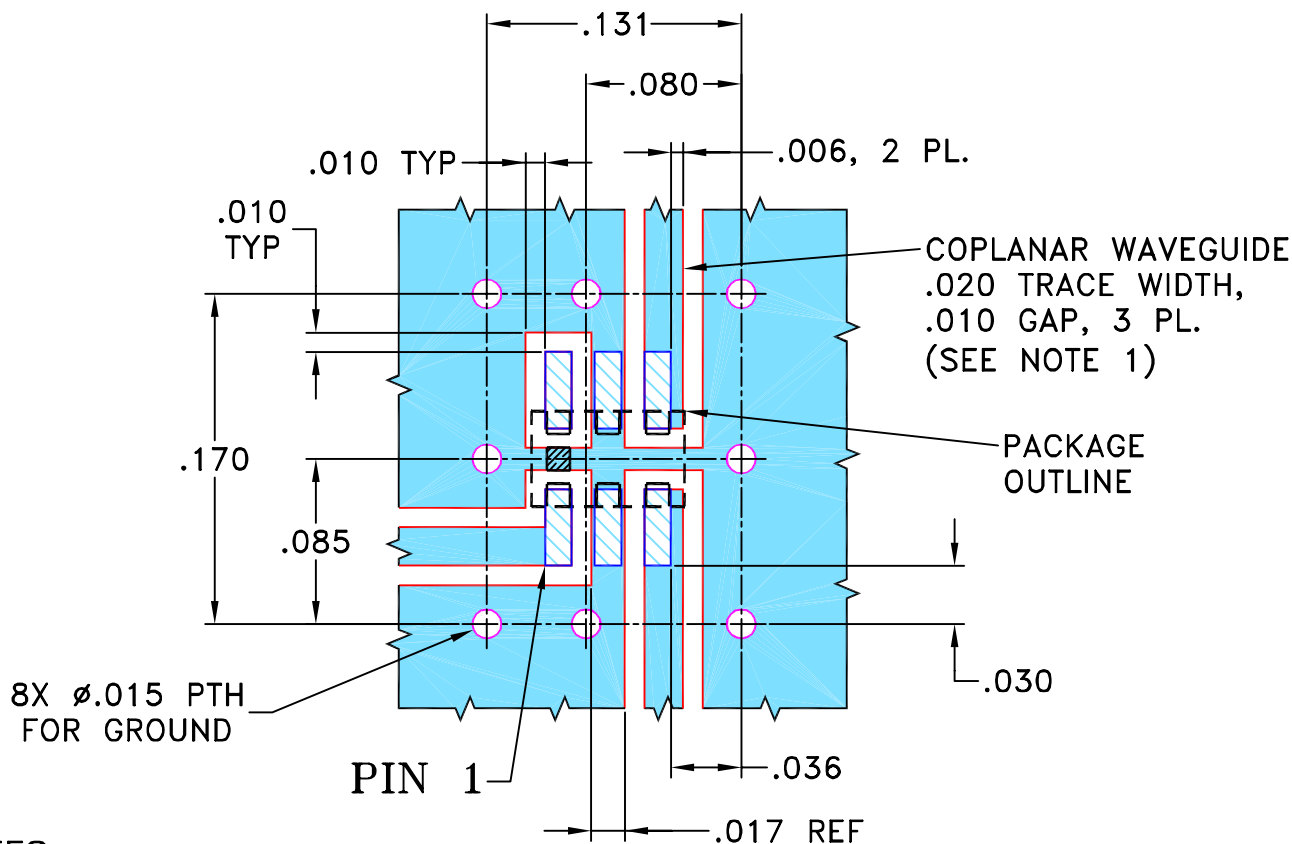
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THIRD ANGLE PROJECTION		REVISIONS				
		REV	ECN No.	DESCRIPTION	DATE	DR
		OR	M109549	NEW RELEASE	01/31/07	PW

**SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-1 CASE STYLE, "ry" PIN CONNECTION.**

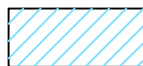


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .010" \pm .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

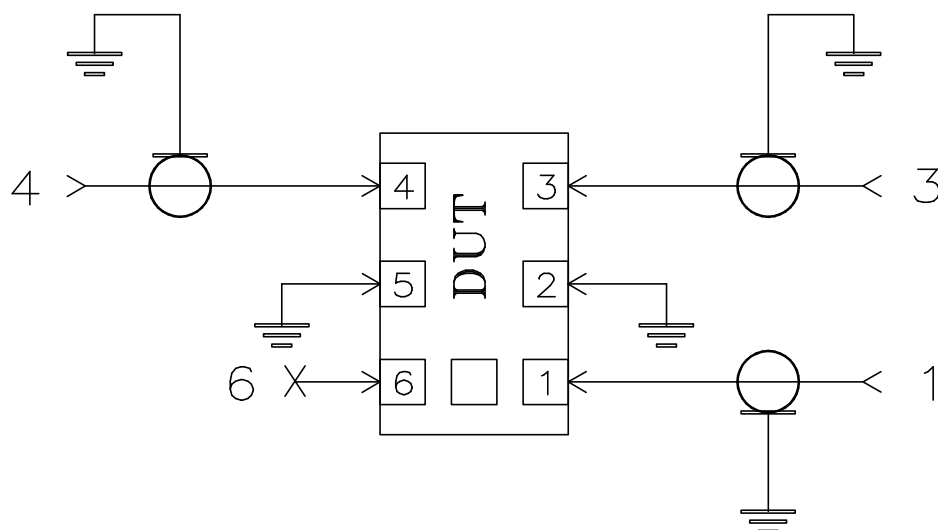
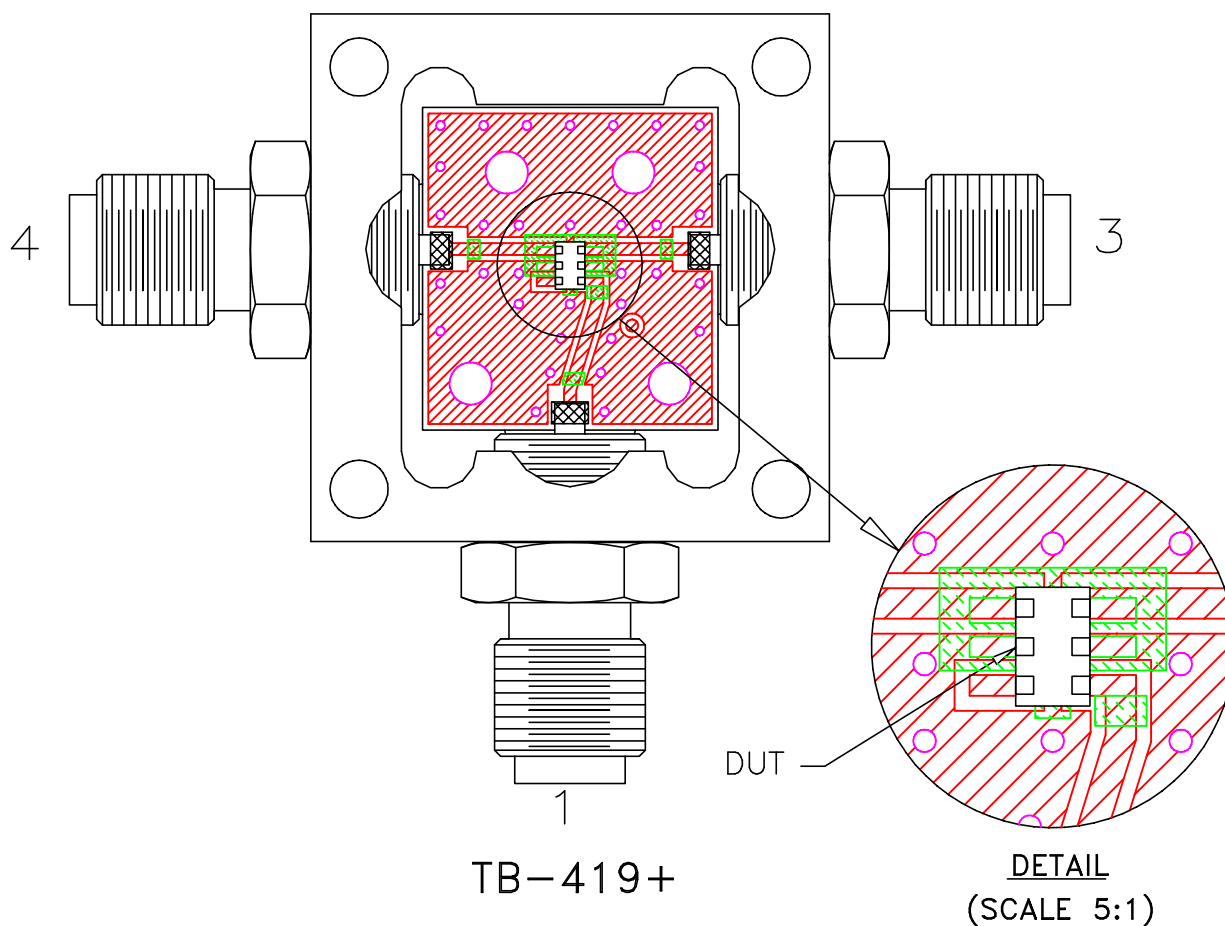


DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

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		FILE:		98PL264		SCALE:		10:1		SHEET:		1 OF 1	
				ASHEETA1.DWG REV:A DATE:01/12/95									

Evaluation Board and Circuit


For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.010 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A